

### **Technical Data Sheet**

## 0603 Package Chip LED (0.6mm Height)

#### 19-213/R7C-AN2Q1/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-Free.
- RoHS refer to SMD B type SGS report

#### **Descriptions**

- The 19-213 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

#### **Device Selection Guide**

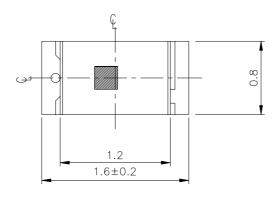
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Part No.	Material	Emitted Color	Lens Color
19-213/R7C-AN2Q1/3T	AlGaInP	Dark -Red	Water Clear

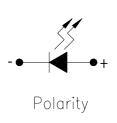


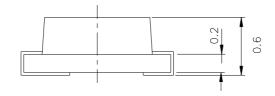
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 10

Device No.: SZDSE-193-R06 Prepared date: 4-Jun-2005 Prepared by:Denhuadong

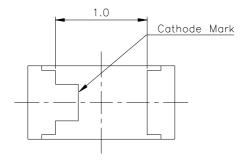
## **Package Outline Dimensions**

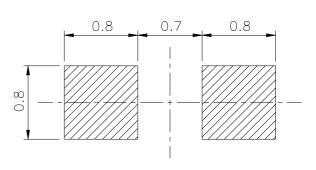






For reflow soldering (Propose)





**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

Everlight Electronics Co., Ltd. Device No. : SZDSE-193-R06 http://www.everlight.com

Rev.1

Page: 2 of 10

Pı

Prepared date: 4-Jun-2005

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## **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	$V_R$	5	V
Forward Current	$I_{\mathrm{F}}$	25	mA
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$ C
Storage Temperature	Tstg	-40~ +90	$^{\circ}\! {\mathbb C}$
Electrostatic Discharge	ESD	2000	V
Power Dissipation	$P_d$	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	$I_{\mathrm{FP}}$	60	mA
Soldering Temperature	Tsol	Reflow Soldering:260 °C for 10 sec Hand Soldering:350°C for 3 sec	$^{\circ}\!\mathbb{C}$

## **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	36.0		90.0	mcd	
Peak Wavelength	λp		639		nm	
Dominant Wavelength	λd	625.5		637.5	nm	
Spectrum Radiation Bandwidth	Δλ		20		nm	IF=20mA
Viewing Angle	2 \theta 1/2		120		deg	
Forward Voltage	VF	1.7	2.0	2.4	V	
Reverse Current	Ir			10	$\mu$ A	V <sub>R</sub> =5V

#### **Notes:**

1. Tolerance of Luminous Intensity  $\pm 10\%$ 

2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10

Device No.: SZDSE-193-R06 Prepared date: 4-Jun-2005 Prepared by: Denghuadong



### Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
	E6	625.5	629.5	nm	nm IF=20mA
A	E7	629.5	633.5		
	E8	633.5	637.5		

### **Bin Range Of Luminous Intensity**

		<u> </u>		
Bin	Min	Max	Unit	Condition
N2	36.0	45.0		
P1	45.0	57.0		1 20 1
P2	57.0	72.0	mcd	IF=20mA
Q1	72.0	90.0		

#### **Notes:**

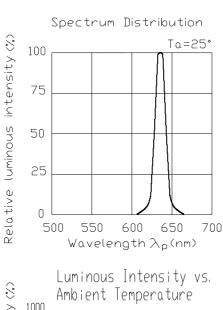
1.Tolerance of Luminous Intensity ±10%

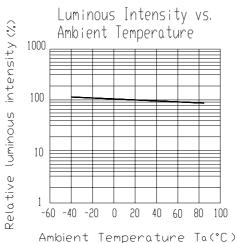
2.Tolerance of Dominant Wavelength ±1nm

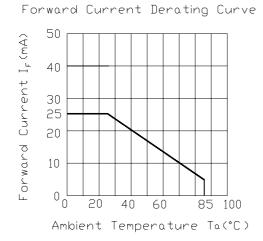
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 10

Device No.: SZDSE-193-R06 Prepared date: 4-Jun-2005 Prepared by: Denghuadong

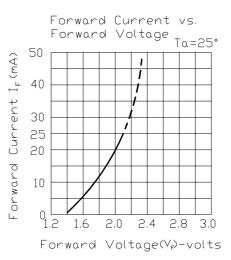
### **Typical Electro-Optical Characteristics Curves**

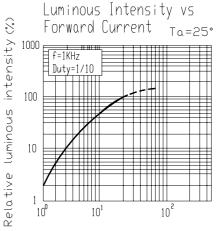


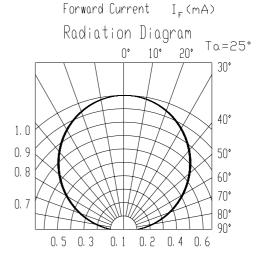




Device No.: SZDSE-193-R06







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Everlight Electronics Co., Ltd. Rev.1 Page: 5 of 10 http://www.everlight.com Prepared date: 4-Jun-2005

### Label explanation

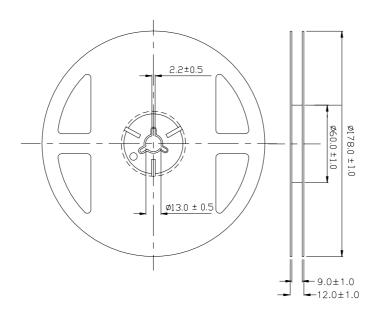
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**



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**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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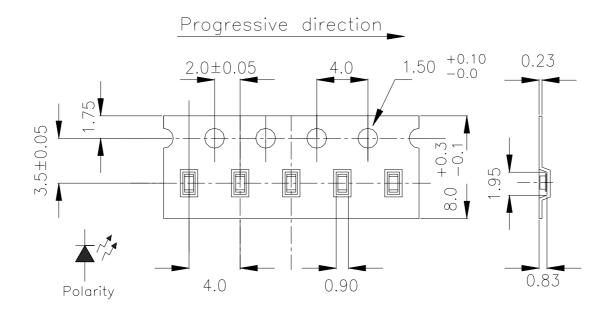
Device No.: SZDSE-193-R06

Rev.1

Page: 6 of 10

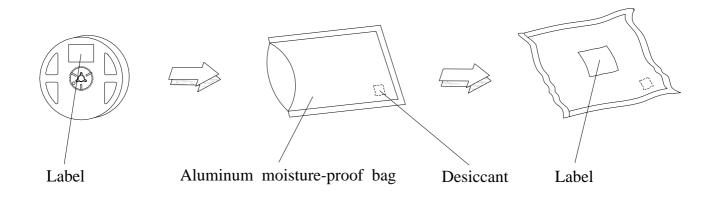
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### Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

### **Moisture Resistant Packaging**



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Prepared date: 4-Jun-2005

Rev.1

Page: 7 of 10

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# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 10

Device No.: SZDSE-193-R06 Prepared date: 4-Jun-2005 Prepared by: Denghuadong

#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

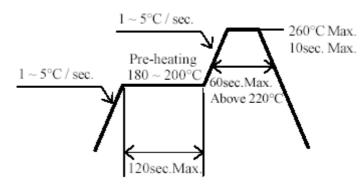
#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4. Soldering Iron

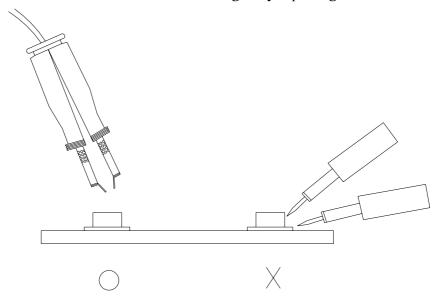
Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 10 Device No.: SZDSE-193-R06 Prepared date: 4-Jun-2005 Prepared by: Denghuadong



#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. Rev.1 Page: 10 of 10 http://www.everlight.com

Device No.: SZDSE-193-R06 Prepared date: 4-Jun-2005 Prepared by: Denghuadong